

实验：低功耗系统设计

--基于NUCLEO-L476RG



- 本动手实验的目的是学会自己构建工程，实现STM32L476 不同的低功耗模式和理解如何进入、退出的触发机制，并且对比分析实测功耗和理论推导功耗。
- 实验分成四个个部分：
 - **介绍**:讲解STM32L476 关键的功耗优化特性 (20分钟)
 - **任务1**: 使用STM32CubeMX 建立一个基于NUCLEO-L476RG 板子的功耗测试工程 (15分钟)
 - **任务2**：使用CubeMX来计算NUCLEO-L476RG在不同功耗模式下的理论功耗 (15分钟)
 - **任务3**: 实际测量STM32L476 板子在不同功耗模式下的功耗值，并且和使用STM32CubeMX理论推算的功耗值进行比较分析(40 分钟)
- 总共时间: 90 分钟

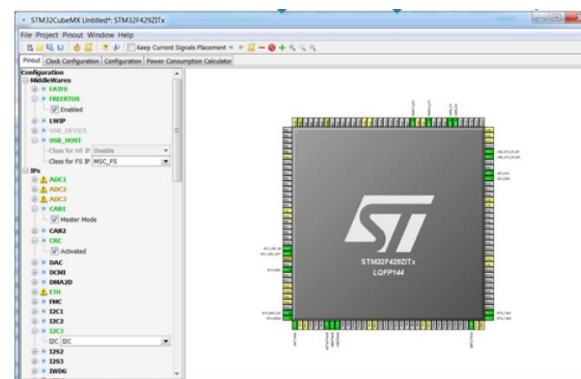
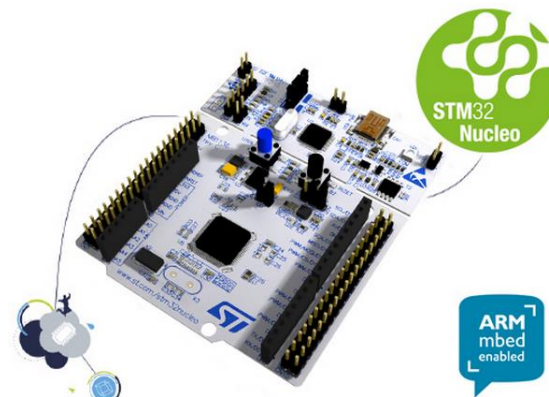
• 硬件准备

- Nucleo-L476RG评估板
- 可测试电流的示波器/万用表
- Mini USB线一根
- PC一台

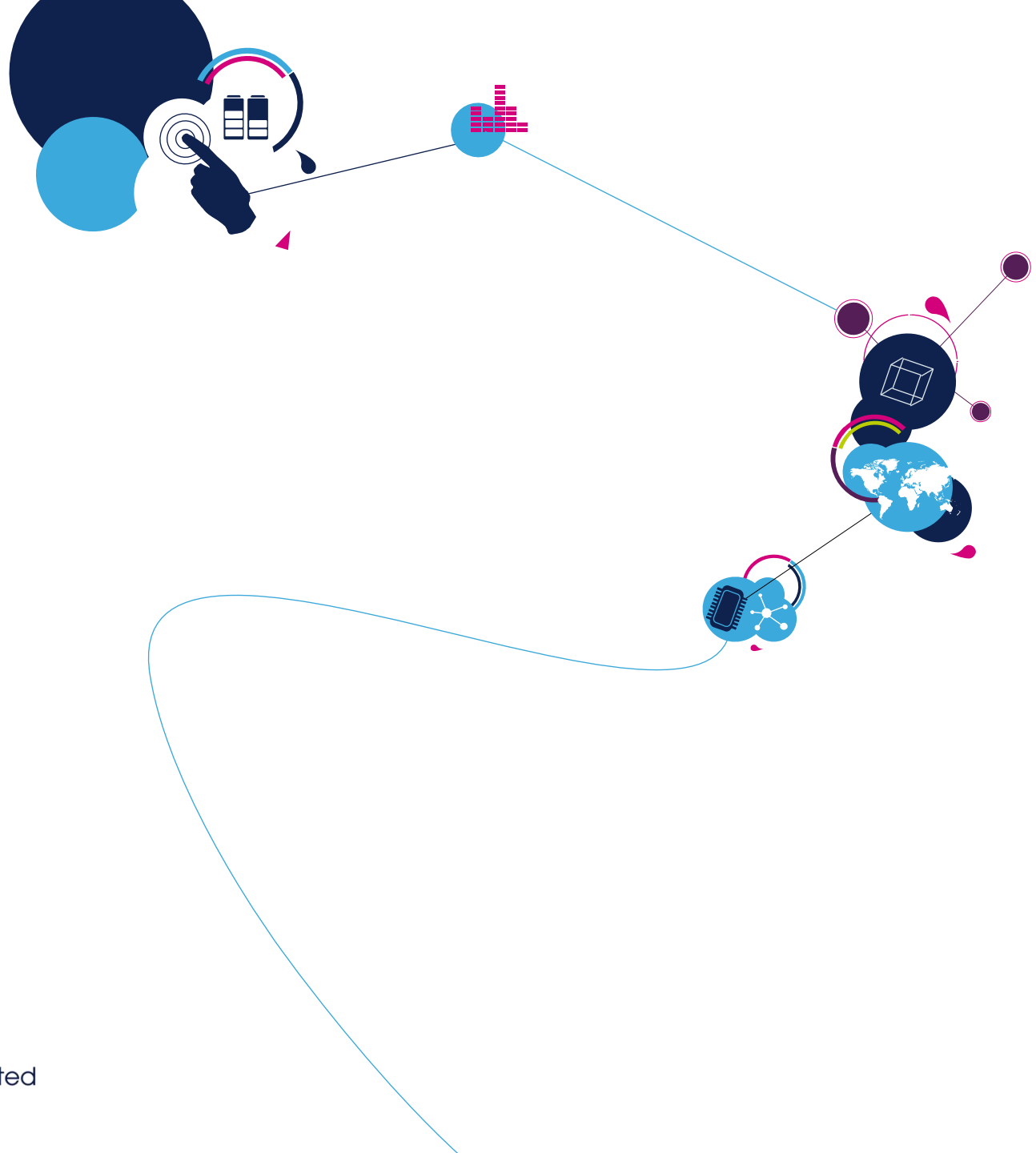
• 软件准备

- IAR V6.7.0 或者以上版本
- STM32CubeL4 V1.6.0
- STM32CubeMX V4.19

• 预计时间: 90分钟

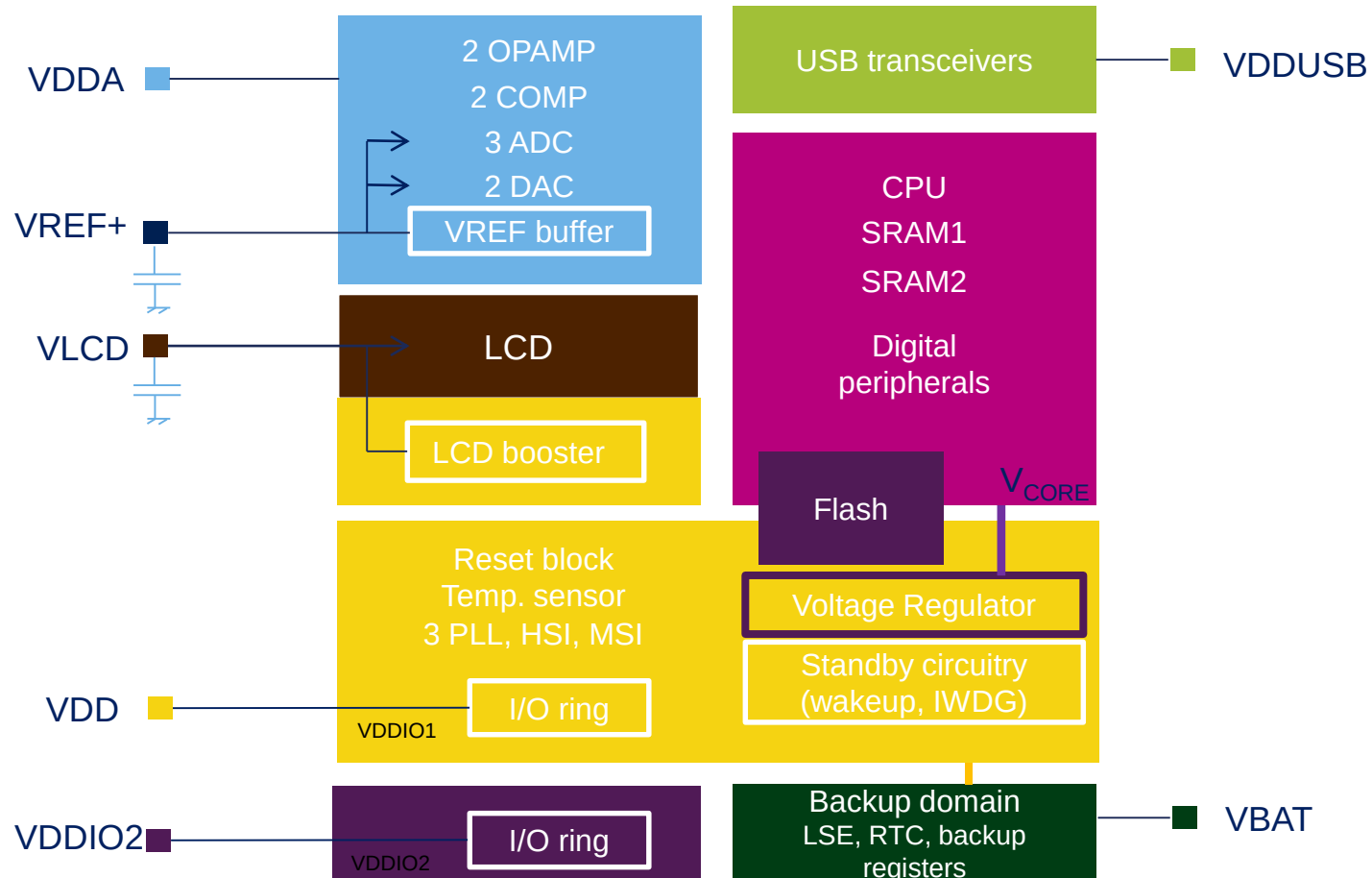


实验环节 - 介绍



MCU电源框架图

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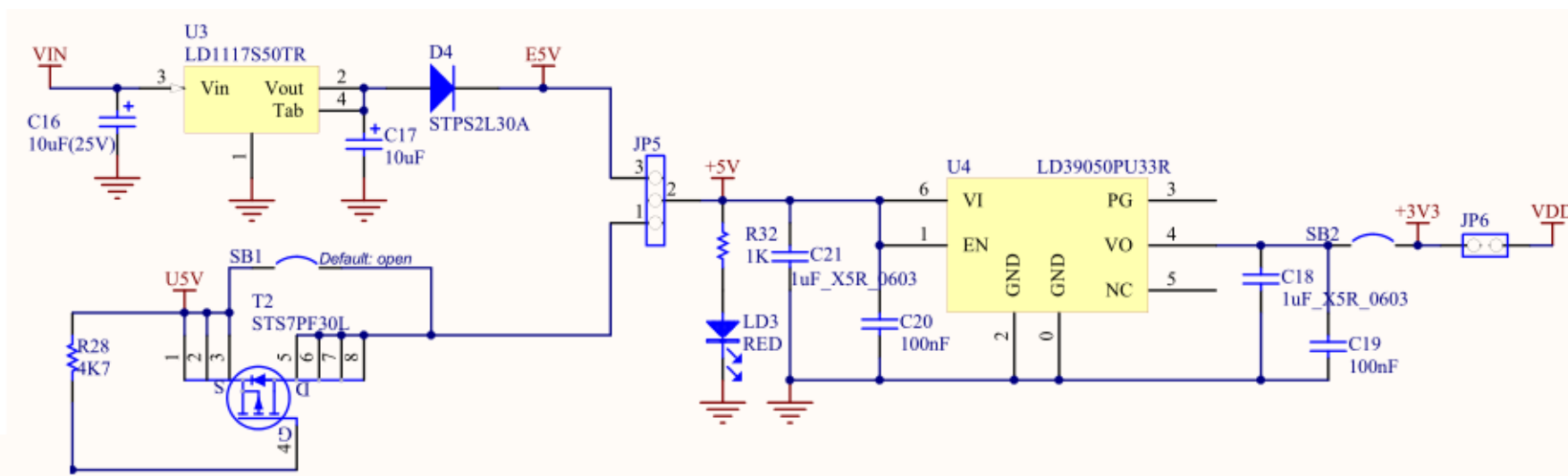


• 供电方式

- 直接USB提供5V供电
- 使用外部5V来给整个系统供电
- 通过JP5这个跳线帽来切换

- 测试点

- 在JP6处串上万用表或者夹上电流探头



实验案例：STM32L4xx

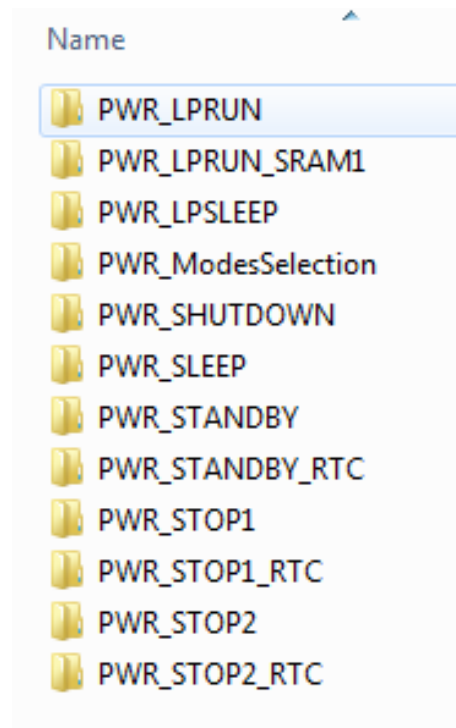
8

- STM32L4xx的低功耗模式比较多：

- Sleep模式
- Low-power run模式
- Low-power sleep模式
- STOP1模式
- STOP2模式
- Standby with SRAM2模式
- Standby 模式
- Shutdown模式

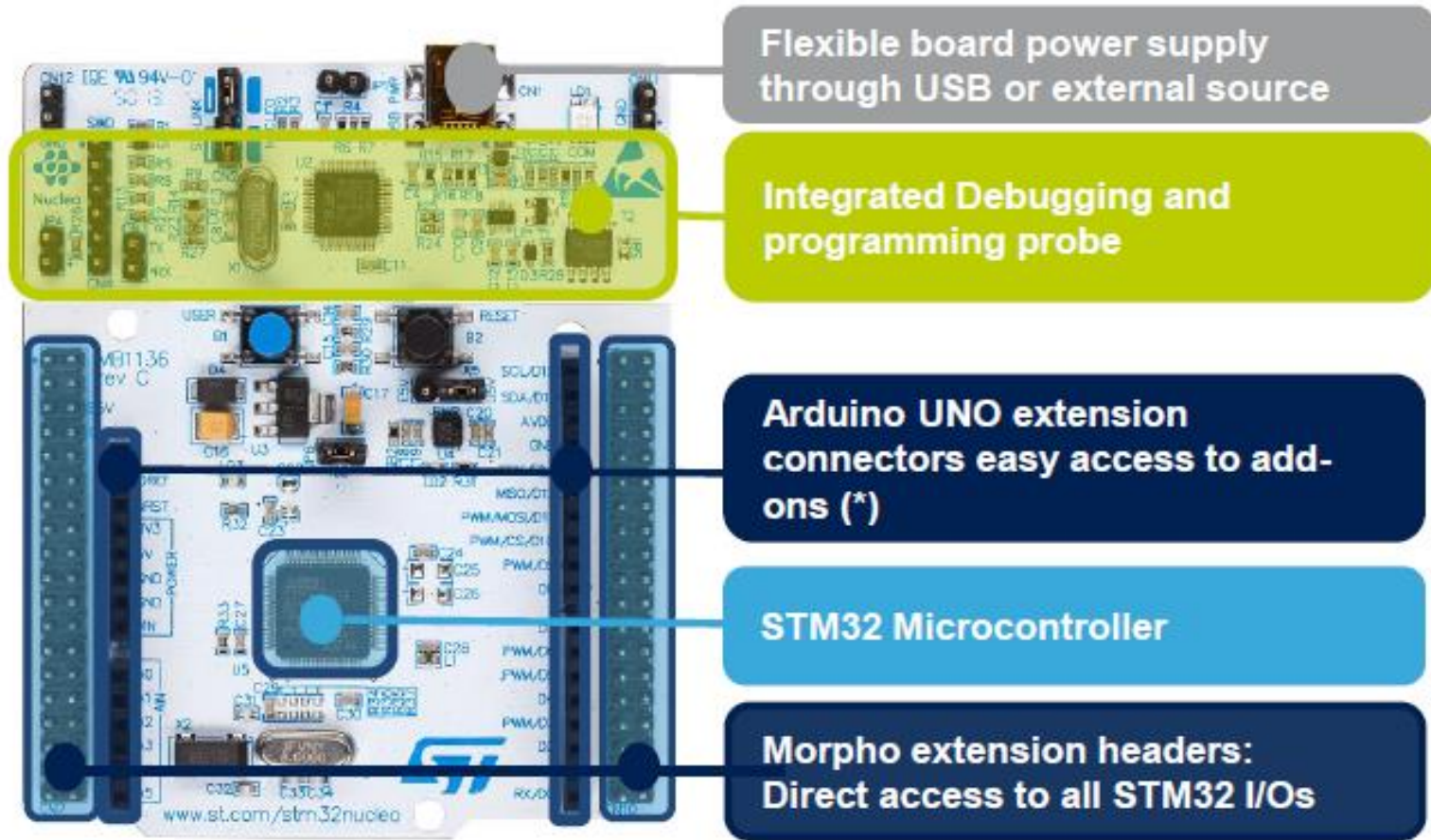
- 所有的范例程序都包含在一下路径：

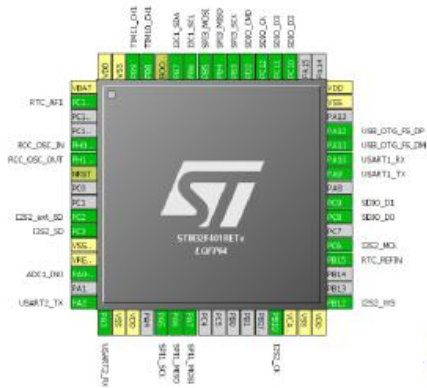
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- STM32Cube_FW_L4_V1.x.x\Projects\STM32L476RG-Nucleo\Examples_LL\PWR
- STM32Cube_FW_L4_V1.x.x\Projects\STM32L476RG-Nucleo\Examples_MIX\PWR



NUCLEO-L476RG

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Pinout Wizard

STM32CubeMX

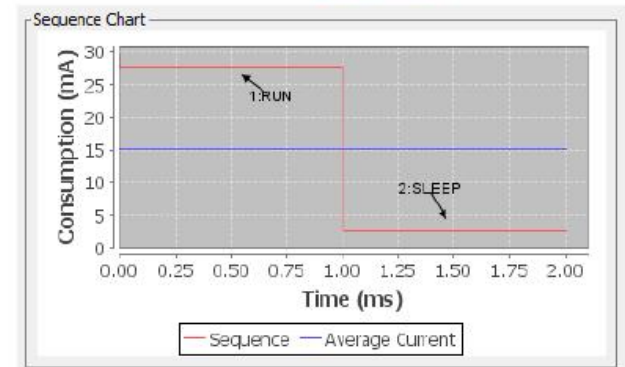
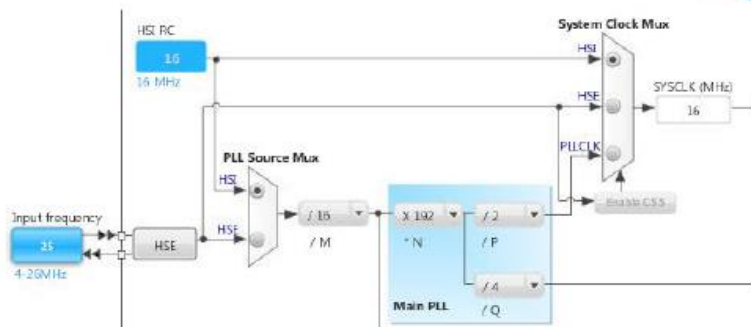


Basic Parameters	
Baud Rate	115200 Bits/s
Word Length	8 Bits (including Parity)
Parity	None
Stop Bits	1
Advanced Parameters	
Data Direction	Receive and Transmit
Over Sampling	16 Samples
Baud Rate	
BaudRate must be between 110 Bits/s and 10.5 MBits/s.	

Peripherals & Middleware Wizard

Power Consumption Wizard

Clock Tree wizard



Low-power modes summary

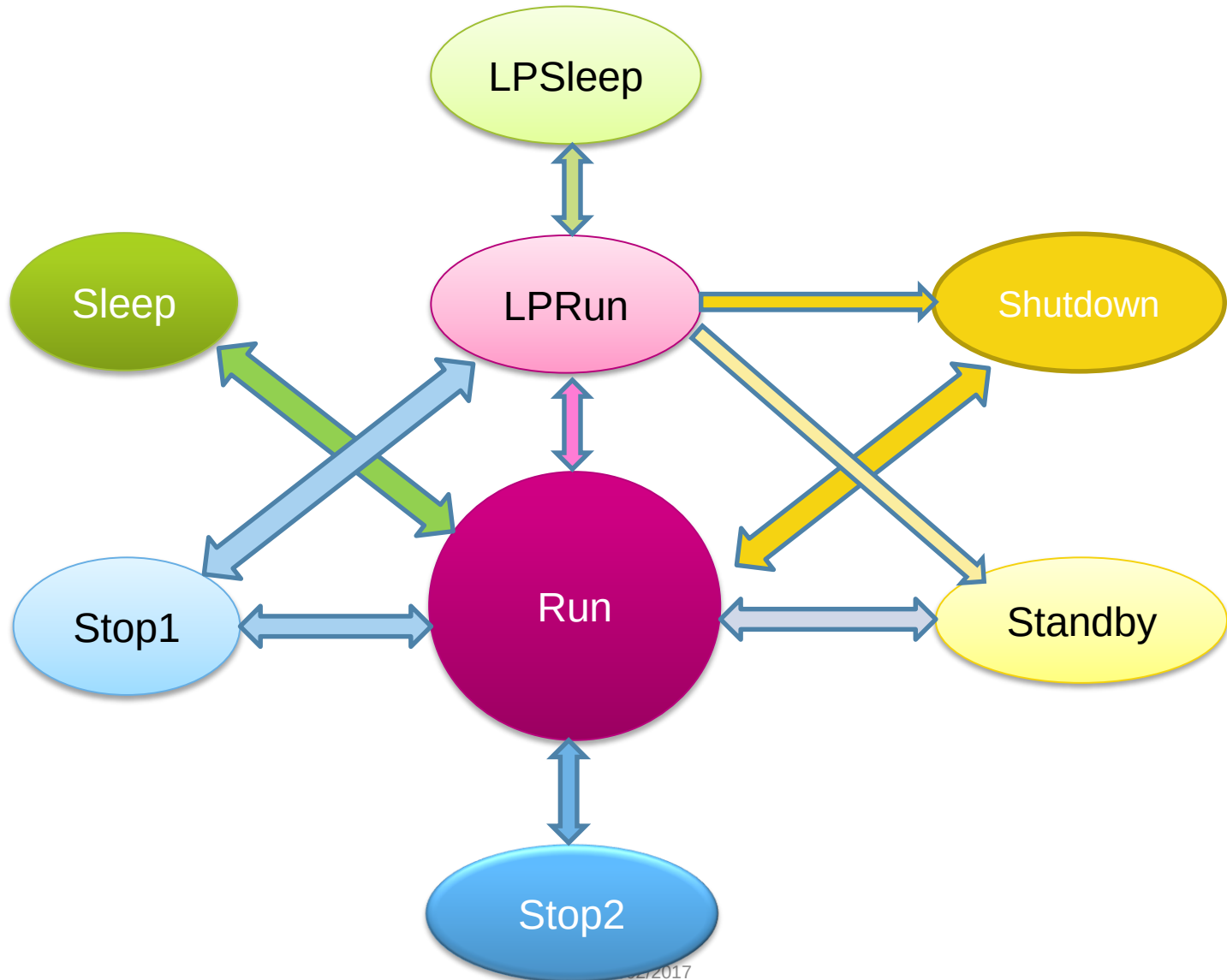
12

Mode	Regulator	CPU	Flash	SRAM	Clocks	Peripherals In Bold : wakeup source	Consumption @ 1.8V	Wakeup time
Run	R1	Yes	ON ⁽¹⁾	ON	Any	All	127 µA/MHz	N/A
	R2					All except OTG, SDMMC, RNG	111 µA/MHz	
LPRun	LPR	Yes	ON ⁽¹⁾	ON	Any except PLL	All except OTG, SDMMC, RNG	136 µA/MHz	TBD
Sleep	R1	No	ON ⁽¹⁾	ON ⁽²⁾	Any	All Any IT or event	37 µA/MHz	6 cycles
	R2						35 µA/MHz	
LPSleep	LPR	No	ON ⁽¹⁾	ON ⁽²⁾	Any except PLL	All except OTG, SDMMC, RNG Any IT or event	40 µA/MHz	6 cycles
Stop 1	LPR	No	OFF	ON	LSE/LSI	Reset pin, all I/Os BOR,PVD,PVM,RTC,LCD,IWDG, COMPx,DACx,OPAMPx,USARTx, LPUART,I2Cx,LPTIMx,OTG_FS, SWPMI	7.3µA w/o RTC 7.6 µA w/RTC	4 µA RAM 6 µA Flash
Stop 2	LPR	No	OFF	ON	LSE/LSI	Reset pin, all I/Os BOR,PVD,PVM,RTC,LCD,IWDG, COMPx,LPUART,I2C3,LPTIM1	1.2 µA w/o RTC 1.4 µA w/RTC	5 µs RAM 7 µs Flash
Standby	LPR	DOWN	OFF	SRAM2 ON	LSE/LSI	Reset pin, 5 WKUPx pins BOR, RTC, IWDG	+ 235 nA	14 µs
	OFF			DOWN			128 nA w/o RTC 433 nA w/RTC	
Shutdown	OFF	DOWN	OFF	DOWN	LSE	Reset pin, 5 WKUPx pins RTC	43 nA w/o RTC 265 nA w/RTC	256 µs

1. Can be put in power-down and clock can be gated off
2. SRAM1 and SRAM2 can be gated off independently

Low-power modes transitions

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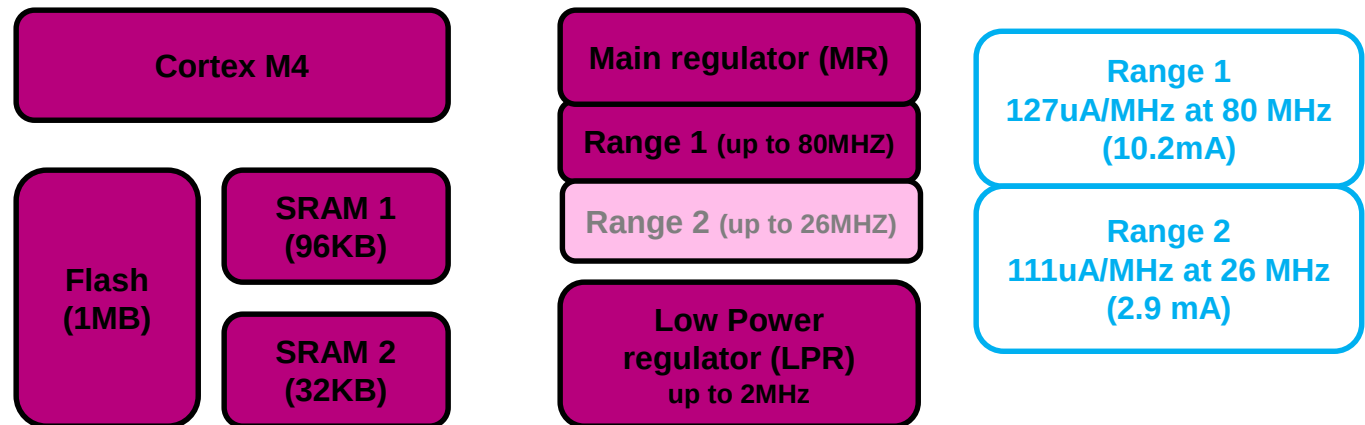


STM32L4 Power Mode

Run mode

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Run Mode Range 1
Ex: execution from Flash



Available Clock

Available Peripheral	
GPIO	
DMA	
FSMC	
QUADSPI	
BOR	
PVD, PVM	
LCD	
USB OTG	
USART	
LP UART	
I2C 1 / I2C 2	
I2C 3	
SPI	
CAN	
SDMMC	
SWPMI	
SAI	
DFSDM	
ADC	
DAC	
OPAMP	
COMP	
Temp Sensor	
Timers	
LPTIM 1	
LPTIM 2	
IWDG	
WWDG	
Systick Timer	
Touch Sens	
RNG	
AES	
CRC	

Available Clock	
HSI	
HSE	
LSI	
LSE	
MSI	

Active cell

Frozen cell

Cell in power-down

Available Periph and clock

Available Peripheral

GPIO
DMA
FSMC
QUADSPI
BOR
PVD, PVM
LCD
USB OTG
USART
LP UART
I2C 1 / I2C 2
I2C 3
SPI
CAN
SDMMC
SWPMI
SAI
DFSDM
ADC
DAC
OPAMP
COMP
Temp Sensor
Timers
LPTIM 1
LPTIM 2
IWDG
WWDG
Systick Timer
Touch Sens
RNG
AES
CRC

Available Clock

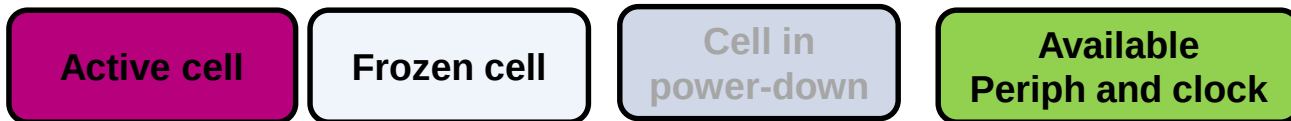
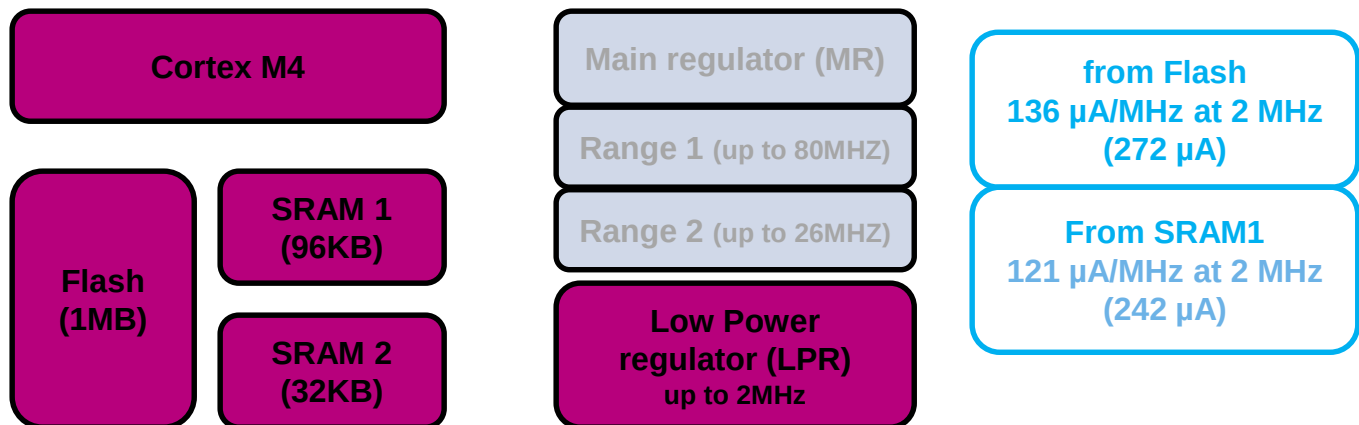
HSI
HSE
LSI
LSE
MSI

STM32L4 Power Mode

Low-power run mode

15

Low-power run mode
Ex: execution from Flash



STM32L4 Power Mode

16

Sleep mode

Sleep Mode Range 1
Ex: Flash ON, SRAMs ON (default)

Zzz

Cortex M4

Main regulator (MR)

Range 1 (up to 80MHz)

Range 2 (up to 26MHz)

Low Power
regulator (LPR)
up to 2MHz

Range 1
37 μ A/MHz at 80 MHz
(2,96 mA)

Range 2
35 μ A/MHz at 26 MHz
(0,92 mA)

Flash
(1MB)

SRAM 1
(96KB)

SRAM 2
(32KB)

Available
Clock

HSI

HSE

LSI

LSE

MSI

Active cell

Frozen cell

Cell in
power-down

Available
Periph and clock

Available
Peripheral

GPIO

DMA

FSMC

QUADSPI

BOR

PVD, PVM

LCD

USB OTG

USART

LP UART

I2C 1 / I2C 2

I2C 3

SPI

CAN

SDMMC

SWPMI

SAI

DFSDM

ADC

DAC

OPAMP

COMP

Temp Sensor

Timers

LPTIM 1

LPTIM 2

IWDG

WWDG

Systick Timer

Touch Sens

RNG

AES

CRC

STM32L4 Power Mode

Low-power sleep mode

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Low-power sleep mode
Ex: Flash OFF, SRAM1 OFF

Zzz

Cortex M4

Main regulator (MR)

Range 1 (up to 80MHz)

Range 2 (up to 26MHz)

Low Power
regulator (LPR)
up to 2MHz

Flash ON, SRAMs OFF
48 μ A/MHz at 2 MHz
(96 μ A)

Flash OFF, SRAMs OFF
40,5 μ A/MHz at 2 MHz
(81 μ A)

Flash
(1MB)

SRAM 1
(96KB)

SRAM 2
(32KB)

Available
Clock

HSI

HSE

LSI

LSE

MSI

Active cell

Frozen cell

Cell in
power-down

Available
Periph and clock

Available
Peripheral

GPIO

DMA

FSMC

QUADSPI

BOR

PVD, PVM

LCD

USB OTG

USART

LP UART

I2C 1 / I2C 2

I2C 3

SPI

CAN

SDMMC

SWPMI

SAI

DFSDM

ADC

DAC

OPAMP

COMP

Temp Sensor

Timers

LPTIM 1

LPTIM 2

IWDG

WWDG

Systick Timer

Touch Sens

RNG

AES

CRC

STM32L4 Power Mode

18

Stop 1 Mode

Stop 1 w/ RTC
on LSE quartz

7,9 μA @3.0V
7.6 μA @1.8V

Zzz

Cortex M4

Main regulator (MR)

Flash
(1MB)

SRAM 1
(96KB)

SRAM 2
(32KB)

Low Power
regulator (LPR)

Backup domain

Backup Register
(32x32-bits)

RTC

Wake-up
event

NRST

BOR

PVD

PVM

RTC + Tamper

LCD

USB OTG

USART

LP UART

I2C 1 / I2C 2

I2C 3

SWPMI

COMP

LPTIM 1

LPTIM 2

IWDG

GPIOs

6 μs wake-up from Flash
4 μs wake-up from RAM

Available Peripheral

GPIO

DMA

FSMC

QSPI

BOR

PVD, PVM

LCD

USB OTG

USART

LP UART

I2C 1 / I2C 2

I2C 3

SPI

CAN

SDMMC

SWPMI

SAI

DFSDM

ADC

DAC

OPAMP

COMP

Temp Sensor

Timers

LPTIM 1

LPTIM 2

IWDG

WWDG

Systick Timer

Touch Sens

RNG

AES

CRC

I/Os kept, and configurable

Available
Clock

HSI

HSE

LSI

LSE

MSI

STM32L4 Power Mode

Stop 1 Mode

19

Stop 1 w/o RTC

7,5 μ A @ 3.0V
7.3 μ A @ 1.8V

Zzz

Cortex M4

Main regulator (MR)

Flash
(1MB)

SRAM 1
(96KB)

SRAM 2
(32KB)

Low Power
regulator (LPR)

Backup domain

Backup Register
(32x32-bits)

RTC

Wake-up
event

NRST

BOR

PVD

PVM

RTC + Tamper

LCD

USB OTG

USART

LP UART

I2C 1 / I2C 2

I2C 3

SWPMI

COMP

LPTIM 1

LPTIM 2

IWDG

GPIOs

6 μ s wake-up from Flash
4 μ s wake-up from RAM

Available
Peripheral

GPIO

DMA

FSMC

QSPI

BOR

PVD, PVM

LCD

USB OTG

USART

LP UART

I2C 1 / I2C 2

I2C 3

SPI

CAN

SDMMC

SWPMI

SAI

DFSDM

ADC

DAC

OPAMP

COMP

Temp Sensor

Timers

LPTIM 1

LPTIM 2

IWDG

WWDG

Systick Timer

Touch Sens

RNG

AES

CRC

I/Os kept, and configurable

Available
Clock

HSI

HSE

LSI

LSE

MSI

STM32L4 Power Mode

20

Stop 2 Mode

Stop 2 w/ RTC
on LSE quartz



1.66 μ A @3.0V
1.43 μ A @1.8V

Zzz

Cortex M4

Main regulator (MR)

Flash
(1MB)

SRAM 1
(96KB)

SRAM 2
(32KB)

Low Power
regulator (LPR)

Backup domain

Backup Register
(32x32-bits)

RTC

Wake-up
event

NRST

BOR

PVD

PVM

RTC + Tamper

LCD

LP UART

I2C 3

COMP

LPTIM 1

IWDG

GPIOs

7 μ s wake-up from Flash
5 μ s wake-up from RAM

Available Peripheral

GPIO

DMA

FSMC

QSPI

BOR

PVD, PVM

LCD

USB OTG

USART

LP UART

I2C 1 / I2C 2

I2C 3

SPI

CAN

SDMMC

SWPMI

SAI

DFSDM

ADC

DAC

OPAMP

COMP

Temp Sensor

Timers

LPTIM 1

LPTIM 2

IWDG

WWDG

Systick Timer

Touch Sens

RNG

AES

CRC

I/Os kept, and configurable

Available
Clock

HSI

HSE

LSI

LSE

MSI

STM32L4 Power Mode

21

Stop 2 Mode

Stop 2 w/o RTC

1.25 μA @3.0V

1.19 μA @1.8V

Zzz

Cortex M4

Main regulator (MR)

Flash
(1MB)

SRAM 1
(96KB)

SRAM 2
(32KB)

Low Power
regulator (LPR)

Backup domain

Backup Register
(32x32-bits)

RTC

Wake-up
event

NRST

BOR

PVD

PVM

RTC + Tamper

LCD

LP UART

I2C 3

COMP

LPTIM 1

IWDG

GPIOs

7 μs wake-up from Flash
5 μs wake-up from RAM

Available Peripheral

GPIO

DMA

FSMC

QSPI

BOR

PVD, PVM

LCD

USB OTG

USART

LP UART

I2C 1 / I2C 2

I2C 3

SPI

CAN

SDMMC

SWPMI

SAI

DFSDM

ADC

DAC

OPAMP

COMP

Temp Sensor

Timers

LPTIM 1

LPTIM 2

IWDG

WWDG

Systick Timer

Touch Sens

RNG

AES

CRC

I/Os kept, and configurable

Available
Clock

HSI

HSE

LSI

LSE

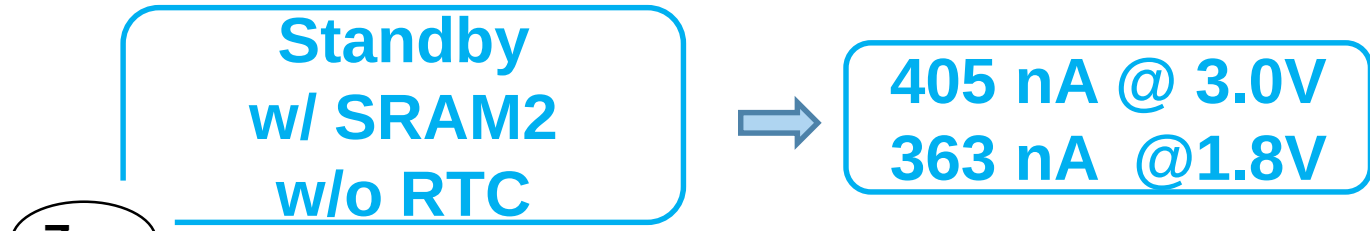
MSI

STM32L4 Power Mode

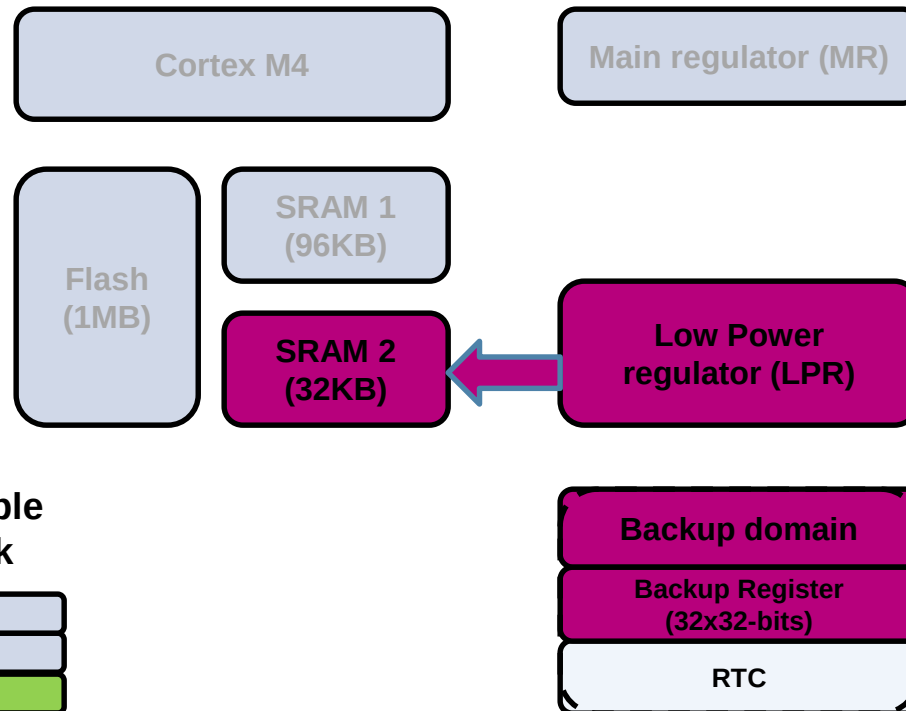
Standby Mode

22

Available Peripheral	
GPIO	I/Os can be configured w/ or w/o pull-up w/ or w/o pull-down
DMA	
FSMC	
QSPI	
BOR	
PVD, PVM	
LCD	
USB OTG	
USART	
LP UART	
I2C 1 / I2C 2	
I2C 3	
SPI	
CAN	
SDMMC	
SWPMI	
SAI	
DFSDM	
ADC	
DAC	
OPAMP	
COMP	
Temp Sensor	
Timers	
LPTIM 1	
LPTIM 2	
IWDG	
WWDG	
Systick Timer	
Touch Sens	
RNG	
AES	
CRC	



Zzz



Wake-up event

NRST
BOR
RTC + Tamper
IWDG
5 WKUP pins

Available Clock

HSI
HSE
LSI
LSE
MSI

14 us wake-up

STM32L4 Power Mode

Standby Mode

23

Available Peripheral

GPIO
DMA
FSMC
QSPI
BOR
PVD, PVM
LCD
USB OTG
USART
LP UART
I2C 1 / I2C 2
I2C 3
SPI
CAN
SDMMC
SWPMI
SAI
DFSDM
ADC
DAC
OPAMP
COMP
Temp Sensor
Timers
LPTIM 1
LPTIM 2
IWDG
WWDG
Systick Timer
Touch Sens
RNG
AES
CRC

I/Os can be configured
w/ or w/o pull-up
w/ or w/o pull-down

**Standby w/ RTC
on LSE quartz**

Zzz

Cortex M4

Main regulator (MR)

Flash
(1MB)

SRAM 1
(96KB)

SRAM 2
(32KB)

Low Power
regulator (LPR)

Backup domain

Backup Register
(32x32-bits)

RTC

**Wake-up
event**

NRST

BOR

RTC + Tamper

IWDG

5 WKUP pins

14 us wake-up

**Available
Clock**

HSI

HSE

LSI

LSE

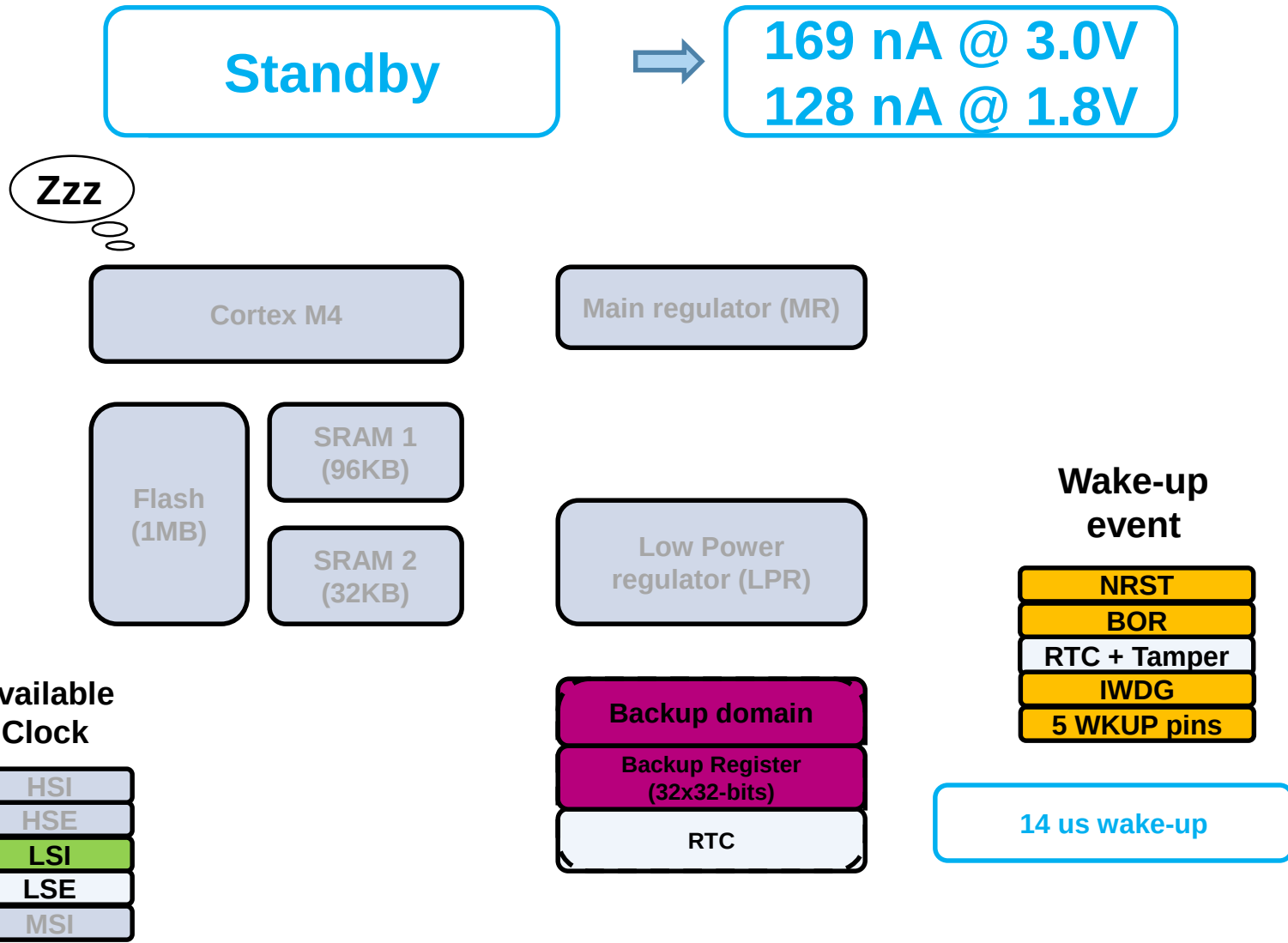
MSI

STM32L4 Power Mode

Standby Mode

24

Available Peripheral	
GPIO	I/Os can be configured w/ or w/o pull-up w/ or w/o pull-down
DMA	
FSMC	
QSPI	
BOR	
PVD, PVM	
LCD	
USB OTG	
USART	
LP UART	
I2C 1 / I2C 2	
I2C 3	
SPI	
CAN	
SDMMC	
SWPMI	
SAI	
DFSDM	
ADC	
DAC	
OPAMP	
COMP	
Temp Sensor	
Timers	
LPTIM 1	
LPTIM 2	
IWDG	
WWDG	
Systick Timer	
Touch Sens	
RNG	
AES	
CRC	



STM32L4 Power Mode

Shutdown Mode

25

Available Peripheral

GPIO
DMA
FSMC
QSPI
BOR
PVD, PVM
LCD
USB OTG
USART
LP UART
I2C 1 / I2C 2
I2C 3
SPI
CAN
SDMMC
SWPMI
SAI
DFSDM
ADC
DAC
OPAMP
COMP
Temp Sensor
Timers
LPTIM 1
LPTIM 2
IWDG
WWDG
Systick Timer
Touch Sens
RNG
AES
CRC

I/Os can be configured
w/ or w/o pull-up
w/ or w/o pull-down
But floating when exit from Shutdown

Shutdown

77 nA @ 3.0V
43 nA @ 1.8V

Zzz

Cortex M4

Main regulator (MR)

Flash
(1MB)

SRAM 1
(96KB)

SRAM 2
(32KB)

Low Power
regulator (LPR)

Wake-up
event

NRST

RTC + Tamper

5 WKUP pins

256 us wake-up

Available
Clock

HSI

HSE

LSI

LSE

MSI

Backup domain

Backup Register
(32x32-bits)

RTC

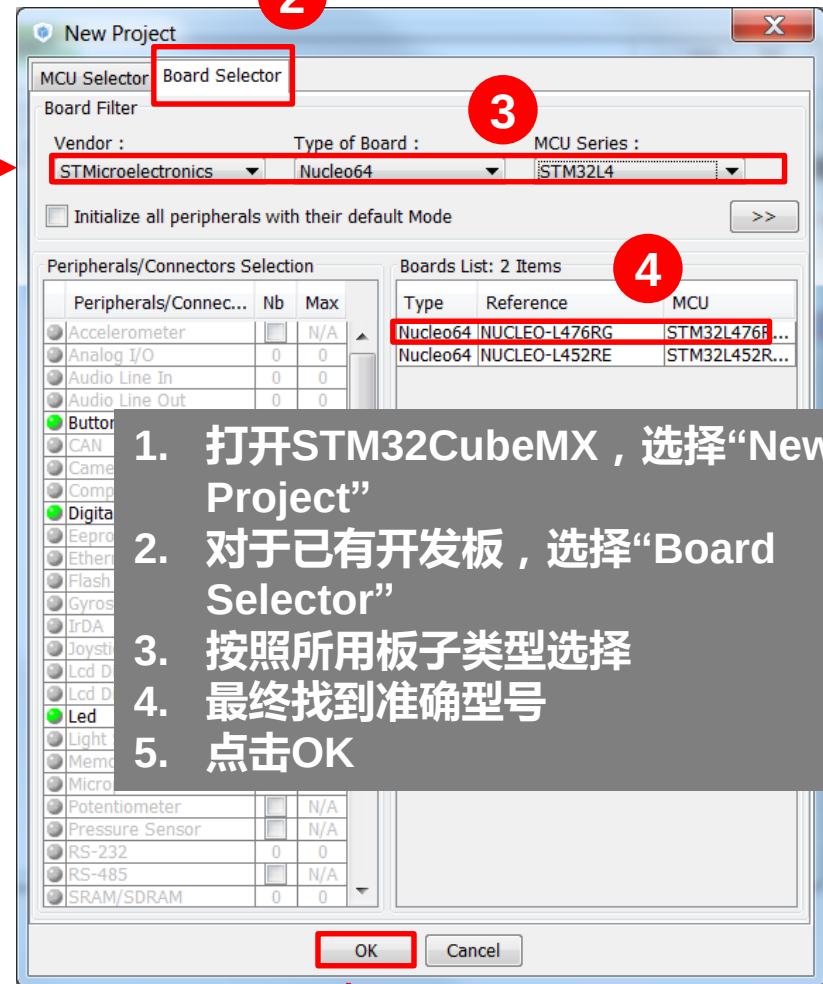
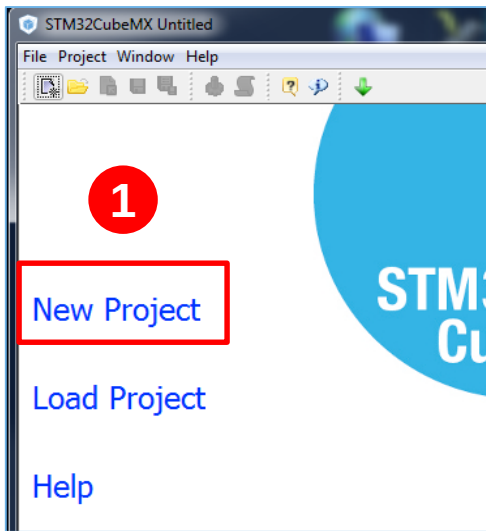


实验环节

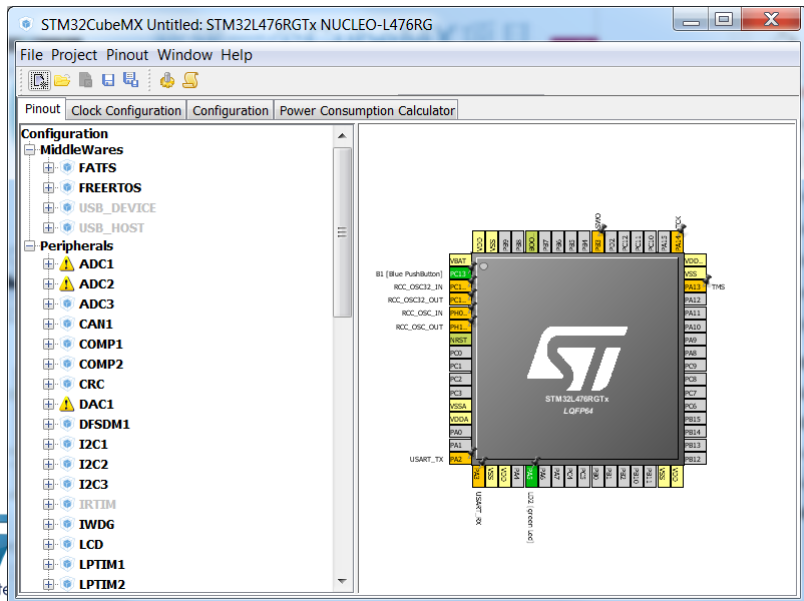
-- **任务1:** 使用STM32CubeMX 建立一个基于NUCLEO-L476RG 板子的功耗测试工程

Step 1: 新建一个CubeMX工程

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1. 打开STM32CubeMX，选择“New Project”
2. 对于已有开发板，选择“Board Selector”
3. 按照所用板子类型选择
4. 最终找到准确型号
5. 点击OK

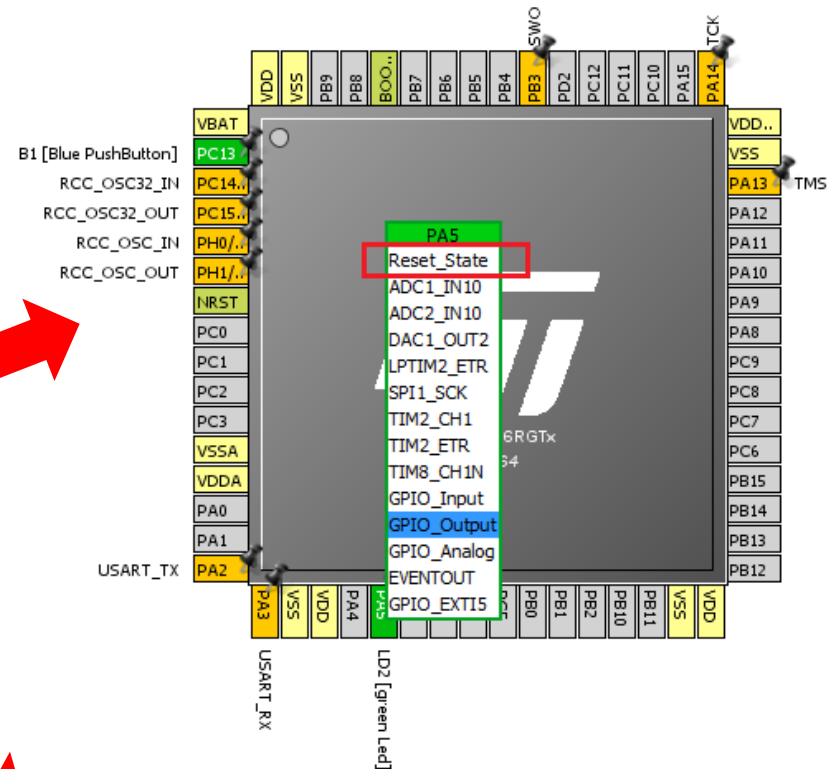


Step 2:引脚配置

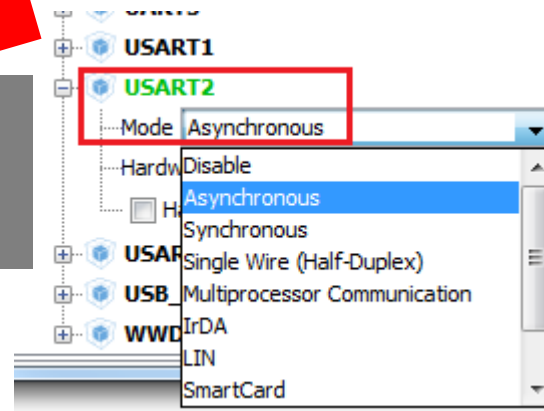
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• 配置需要使用的外设引脚：

- SYS
- SWD Options
- GPIO
 - PA5 Reset
- USART
 - 实现串口打印



1. PA5选择“Reset_State”
2. 根据所用板子，选择实现串口打印的外设端口，配置成Asynchronous



Step 4: 外设配置

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STM32CubeMX LowPowerTestLisa.ioc: STM32L476RGTx NUCLEO-L476RG

File Project Window Help

Pinout Clock Configuration **Configuration** Power Consumption Calculator

Configuration 1

- MiddleWares
 - FATFS
 - User-defined
 - FREERTOS
 - Enabled
- Peripherals
 - CRC
 - Activated
 - IWDG
 - Activated
 - RNG
 - Activated
 - SYS
 - Timebase Source: Sys1
 - TIM6
 - Activated
 - One Pulse Mode
 - TIM7
 - Activated
 - One Pulse Mode
 - USART2**
 - Mode: Asynchronous

Connectivity

USART2 2

USART2 Configuration 3

Parameter Settings User Constants NVIC Settings DMA Settings GPIO Settings

Configure the below parameters :

Search : Search (Ctrl+F)

Basic Parameters 4

Baud Rate	9600 Bits/s
Word Length	8 Bits (including Parity)
Parity	None
Stop Bits	1

Advanced Parameters

Data Direction	Receive and Transmit
Over Sample	
Single Sam	

Advanced Features

Auto Baudr	
TX Pin Acti	
RX Pin Acti	
Data Invers	
TX and RX	
Overrun	
DMA on RX	
MSB First	Disable

Word Length

WordLength

Restore Default Apply **Ok** Cancel

1. CubeMX中选择“Configuration” 进行
外设配置
2. 选择USART2做配置
3. Parameter Setting
4. Baud Rate/ Word Length/ Parity/
Stop Bits做相应配置

Step 4:外设配置(续)

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The screenshot shows the STM32CubeMX interface for STM32L476RGTx NUCLEO-L476RG. The left sidebar shows the 'Configuration' tree with 'USART2' selected under 'Peripherals'. A red dashed line connects this selection to the 'USART2 Configuration' dialog box. The dialog box has tabs for 'Parameter Settings', 'User Constants', 'NVIC Settings', 'GPIO Settings', and 'DMA Settings'. The 'NVIC Settings' tab is active, showing a table with 'USART2 global interrupt' enabled. The 'Ok' button is highlighted.

1. 继续USART2配置

2. NVIC Setting

3. 使能USART2中断

Step5 生成源代码

32

1. Project Settings

2. Code Generator

3. Code Generation

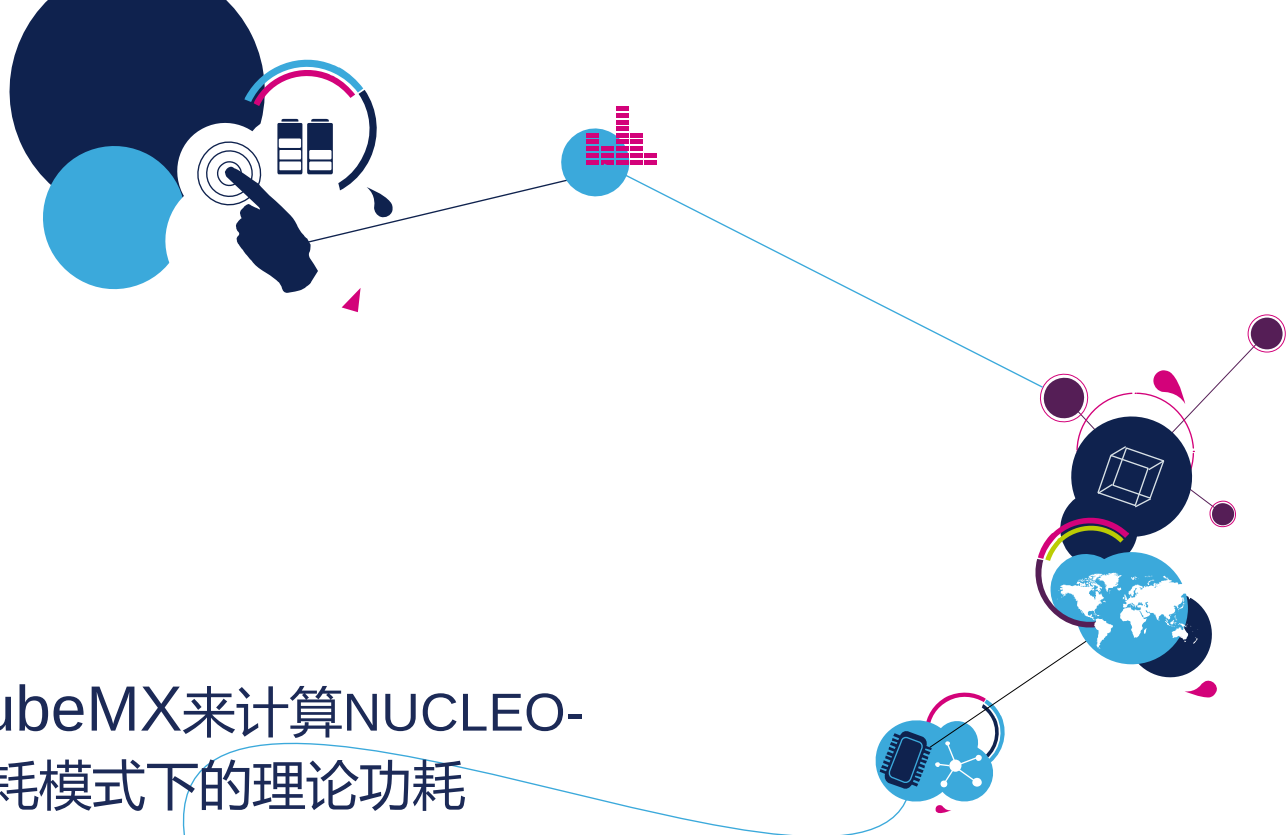
The Code is successfully generated under C:/temp/LowPowerTest/Lisa3

Open Folder Open Project Close

Ok Cancel

配置完成后，用CubeMX生成工程文件

1. 定义文件名，选择保存路径
2. Project Setting → Code Generator 为了降低功耗，将不使用的GPIO设置为模拟输入
3. 生成代码工程



实验环节

-- **任务2**：使用CubeMX来计算NUCLEO-L476RG在不同功耗模式下的理论功耗

功耗计算器的使用

34

1. 选择“Power Consumption Calculator”
2. 选择合适的电池供电
3. 在模型库里，选择3.0V的电池供电Li-MnO₂(CR2032)
4. 点击OK

The screenshot shows the STM32CubeMX interface with the 'Power Consumption Calculator' tab selected. The 'Available Batteries' dialog is open, displaying a list of batteries. The 'Li-MnO₂(CR2032)' battery is highlighted in the list. The 'OK' button is also highlighted.

Available Batteries List

Name	Capacity (mAh)	Self Discharge (%...)	Nominal Voltage (V)	Max Cont Current...	Max Pulse Curren...	Database
Alkaline(AA LR6)	2850.0	0.3	1.5	1000.0	0.0	Default
Alkaline(AAA LR03)	1250.0	0.3	1.5	400.0	0.0	Default
Alkaline(C LR14)	8350.0	0.3	1.5	3000.0	0.0	Default
Alkaline(D LR20)	20500.0	0.3	1.5	7500.0	0.0	Default
Alkaline(9V)	625.0	0.3	9.0	200.0	0.0	Default
Li-MnO ₂ (CR1225)	48.0	0.12	3.0	1.0	5.0	Default
Li-MnO ₂ (CR1632)	125.0	0.12	3.0	1.5	10.0	Default
Li-MnO ₂ (CR2032)	225.0	0.12	3.0	3.0	15.0	Default
Li-MnO ₂ (CR2430)	285.0	0.12	3.0	4.0	20.0	Default
Li-MnO ₂ (CR2477)	850.0	0.12	3.0	2.0	10.0	Default
Li-SOCL2(AAA700)	700.0	0.08	3.6	10.0	30.0	Default

功耗计算器的使用（续）

35

The screenshot displays the STM32CubeMX Lowpower test interface. The main window shows the project configuration for STM32L476RGTx. The 'Power Consumption' tab is active, showing a table with a '+' button (labeled 1). The 'New Step' dialog is open, showing the 'Power/Memory' section with 'Power Mode' set to 'STANDBY' (labeled 2). The 'Clocks' section shows 'Clock Configuration' set to 'ALL CLOCKS OFF' (labeled 3). The 'Optional Settings' section shows 'Step Duration' set to 1 ms and 'Additional Consumption' set to 0 mA. The 'Results' section shows 'Step Consumption' as 150 nA (labeled 4), 'Without Peripherals' as 150 nA, and 'Peripherals Part' as 0 nA (A: 0 nA - D: 0 nA).

1. 选择添加一个New Step

2. 在New Step中选择需要测算的功耗模式

3. 选择时钟配置

4. 最终得出功耗计算器算出的理论值

使用STM32CubeMX的Power Consumption Calculator得出的理论结果：

低功耗模式	理论计算值
SHUTDOWN	64nA
STANDBY	150nA
STOP2	1.18uA
LPSLEEP 2MHz	81uA



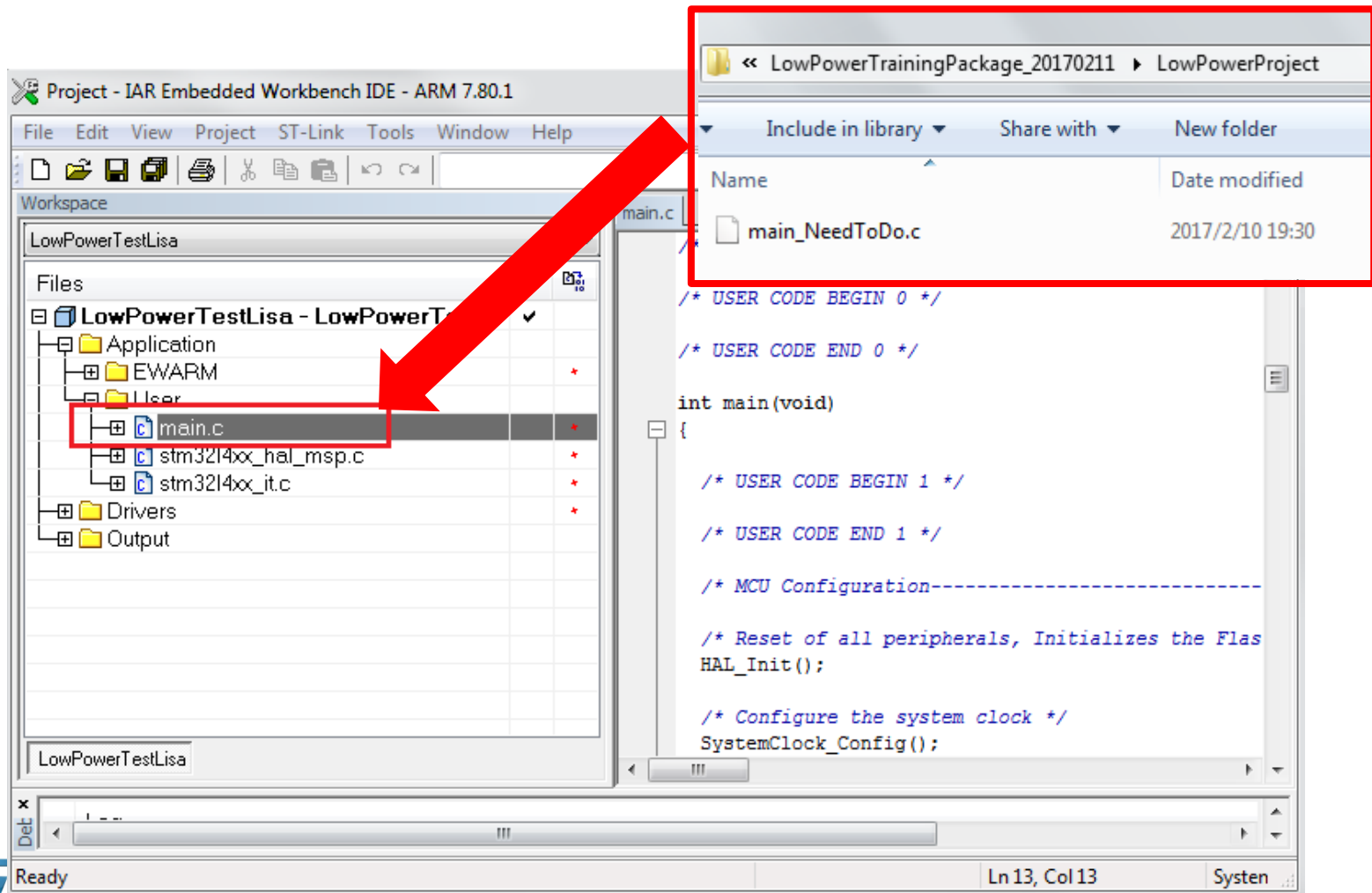
实验环节

-- **任务3:** 实际测量STM32L476 板子在不同功耗模式下的功耗值，并且和使用STM32CubeMX理论推算的功耗值进行比较分析

打开并替换main.c函数

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用培训工程包里的 main_NeedToDo.c内容
替换目前main.c内容



STM32CubeMX USER CODE规则

39

```
/* USER CODE BEGIN PFP */
/* Private function prototypes -----*/
/* USER CODE END PFP */

/* USER CODE BEGIN 0 */
/* USER CODE END 0 */

int main(void)
{
    /* USER CODE BEGIN 1 */
    /* USER CODE END 1 */

    /* MCU Configuration-----*/
    /* Reset of all peripherals, Initializes the Flash interface and the Systick. */
    HAL_Init();

    /* Configure the system clock */
    SystemClock_Config();

    /* Initialize all configured peripherals */
    MX_GPIO_Init();
    MX_USART2_UART_Init();

    /* USER CODE BEGIN 2 */
    /* USER CODE END 2 */

    /* Infinite loop */
    /* USER CODE BEGIN WHILE */
    while (1)
    {
        /* USER CODE END WHILE */

        /* USER CODE BEGIN 3 */
    }
}
```

用户代码必须放在如下的注释之间，这样加入的用户代码不会被CubeMX再生成代码改动：
/*USER CODE BEGIN...*/
/*USER CODE END...*/

CubeMX生成的MCU初始化代码

如何进入Shutdown模式

40

```
void test_shutdown(void)
{
    printf("\n\r Executing test (SHUTDOWN) \n\r");
    printf(" Please measure current then use Reset button to
select another test \n\r");

    /* Set all GPIO in analog state to reduce power
consumption */
    GPIO_AnalogState_Config();

    /* Enable Power Clock */
    __HAL_RCC_PWR_CLK_ENABLE();

    /* Enter the SHUTDOWN mode */
    HAL_PWREx_EnterSHUTDOWNMode();
}
```

Test_shutdown API可以直接拷贝放入main.c的USER CODE区域

```
/*USER CODE BEGIN...*/
/*USER CODE END...*/
```

Search:

// TODO 1: Enter into Shutdown mode

如何进入Standby模式

41

```
void test_standby(void)
{
    printf("\n\r Executing test (STANDBY) \n\r");
    printf(" Please measure current then use Reset button to select\n\r another test \n\r");

    /* Set all GPIO in analog state to reduce power consumption */
    GPIO_AnalogState_Config();

    /* Enable Power Clock */
    __HAL_RCC_PWR_CLK_ENABLE();

    /* Request to enter STANDBY mode */
    HAL_PWR_EnterSTANDBYMode();
}
```

Test_standby API可以直接拷贝放入main.c的USER CODE区域

```
/*USER CODE BEGIN...*/  
/*USER CODE END...*/
```

Search:

// TODO 2: Enter into Standby mode

如何进入STOP模式

42

Test_stop API可以直接拷贝放入
main.c的USER CODE区域
/*USER CODE BEGIN...*/
/*USER CODE END...*/

Search:
// TODO 3: Enter into Stop2 mode

```
void test_stop2(void)
{
    printf("\n\r Executing test (STOP2) \n\r");
    printf(" Please measure current then use Reset button to select\n\r another test \n\r");

    /* Set all GPIO in analog state to reduce power consumption */
    GPIO_AnalogState_Config();

    /* Enable Power Clock */
    __HAL_RCC_PWR_CLK_ENABLE();

    /* Enter STOP 2 mode */
    HAL_PWREx_EnterSTOP2Mode(PWR_STOPENTRY_WFE);
}
```

如何进入Low Power Sleep模式

43

```
void test_lpsleep_2mhz(void)
{
    printf("\n\n Executing test (LPSLEEP 2MHz - FLASH OFF) \n\n");
    printf(" Please measure current then use Reset button to select another test \n\n");

    /* Set all GPIO in analog state to reduce power consumption */
    GPIO_AnalogState_Config();

    /* Enable Flash power down mode during Sleep mode */
    /* (uncomment this line if power consumption figures */
    /* must be measured with Flash still on in Low Power */
    /* Sleep mode) */
    __HAL_FLASH_SLEEP_POWERDOWN_ENABLE();

    /* Set the System clock to 2 MHz (MSI) */
    SystemClock_2MHz();

    /* Suspend Tick increment to prevent wakeup by SysTick interrupt. */
    /* Otherwise the SysTick interrupt will wake up the device within 1ms */
    /* (HAL time base). */
    HAL_SuspendTick();

    /* Switch off all clock enable ... */
    RCC->AHB1SMENR = 0x0;
    RCC->AHB2SMENR = 0x0;
    RCC->AHB3SMENR = 0x0;
    RCC->APB1SMENR1 = 0x0;
    RCC->APB1SMENR2 = 0x0;
    RCC->APB2SMENR = 0x0;

    /* Enable Power Clock */
    __HAL_RCC_PWR_CLK_ENABLE();

    /* Enter SLEEP Mode, Main regulator is OFF */
    HAL_PWR_EnterSLEEPMode(PWR_LOWPOWERREGULATOR_ON, PWR_SLEEPENTRY_WFI);
}
```

Test_lpsleep_2mhz API可以直接拷贝放入main.c的USER CODE区域

```
/*USER CODE BEGIN...*/
/*USER CODE END...*/
```

Search:

// TODO 4: Enter into Low Power Sleep mode

完成低功耗模式API调用

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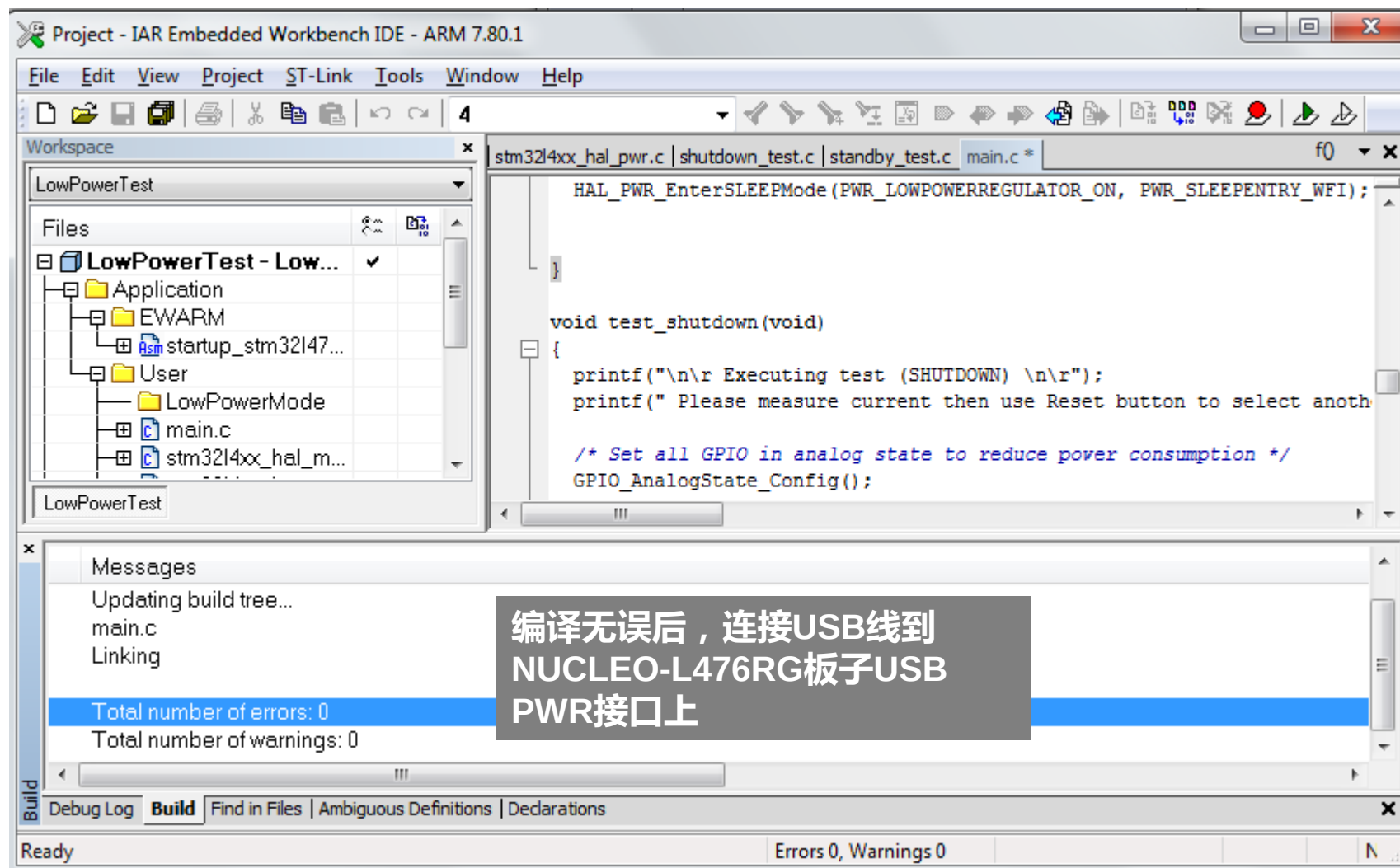
```
// __EFF_NENW1NW2 __ATTRIBUTES int      strcmp(const
char *, const char *)
// strcmp(s, "x\r") ==0, input char is x\r, it is true

// TODO 5: If receive char "0", enter into Shutdown mode

// TODO 6: If receive char "1", enter into Standby mode

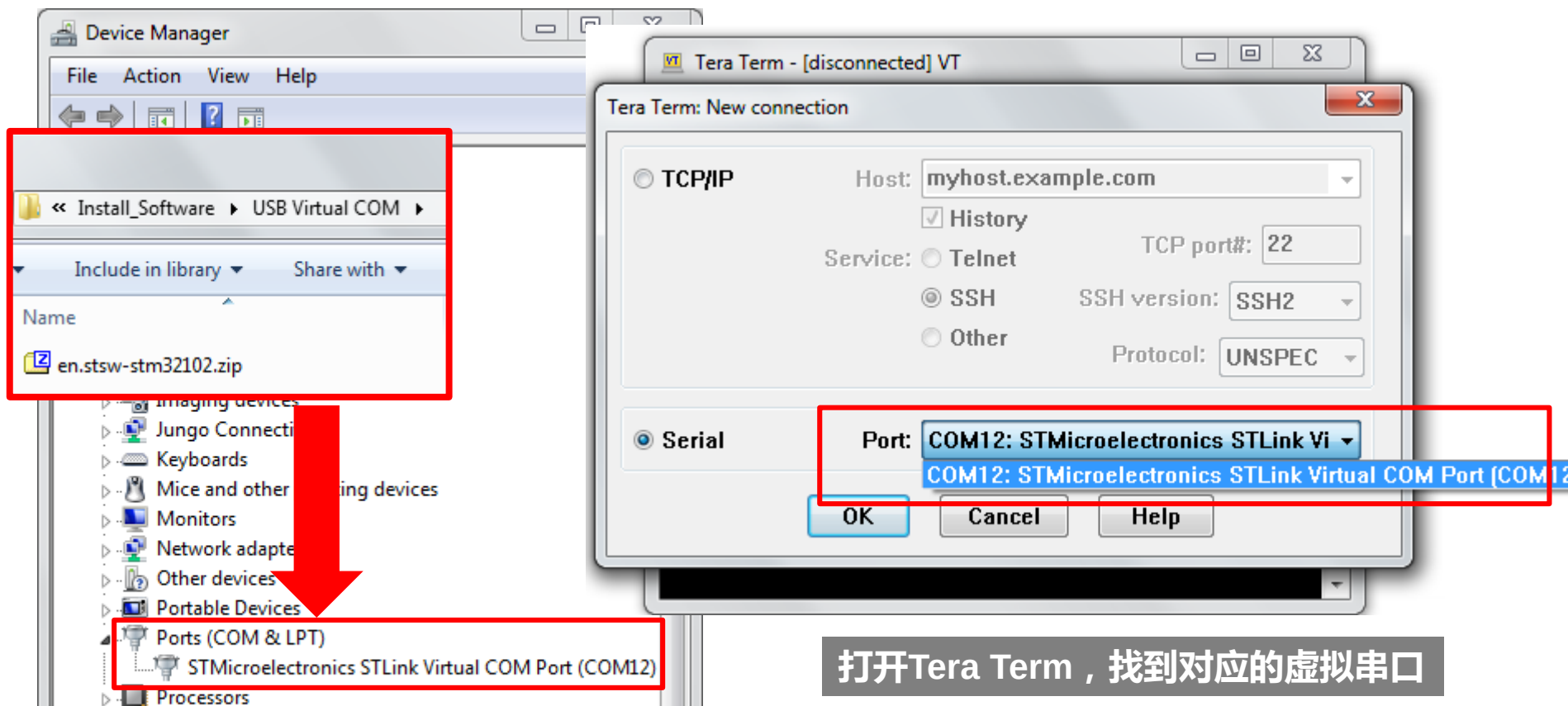
// TODO 7: If receive char "2", enter into Stop2 mode

// TODO 8: If receive char "3", enter into Low Power Sleep
```



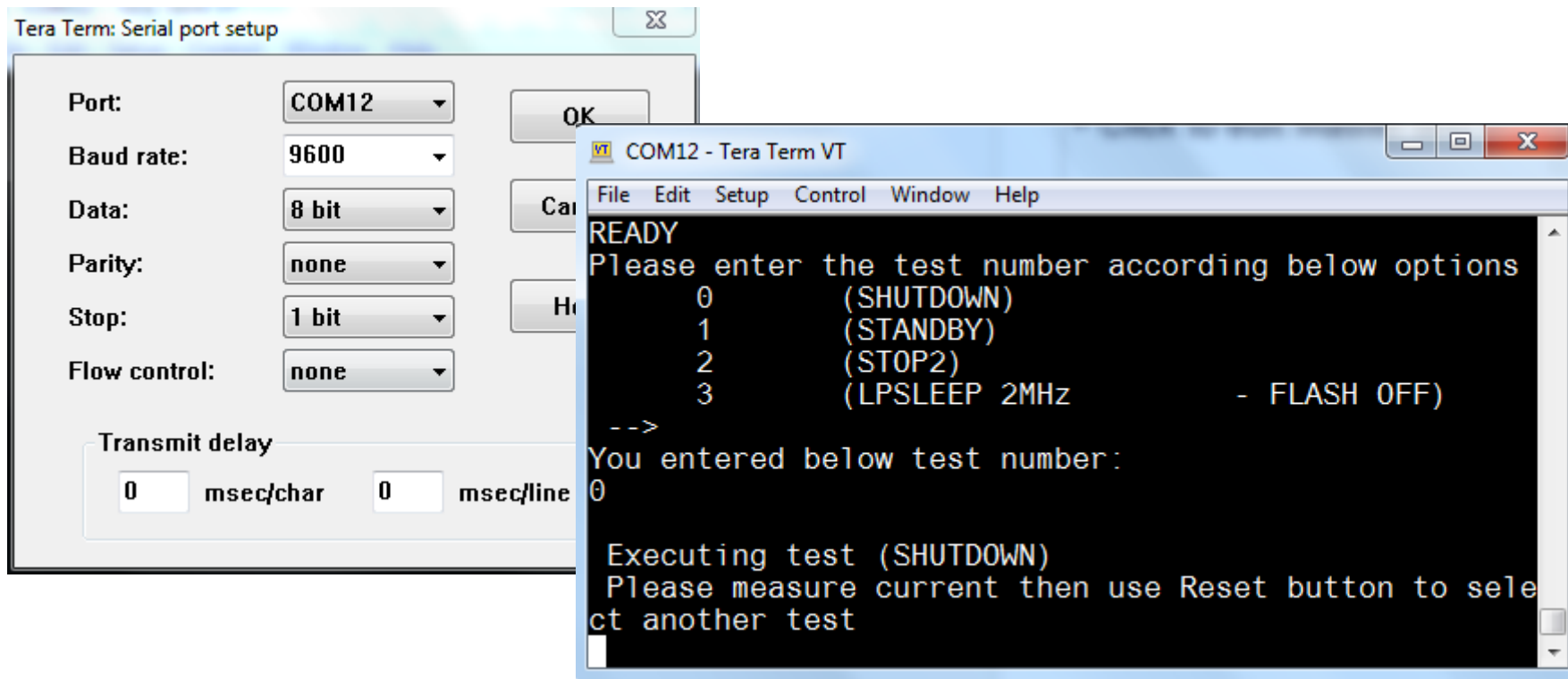
虚拟串口识别

46



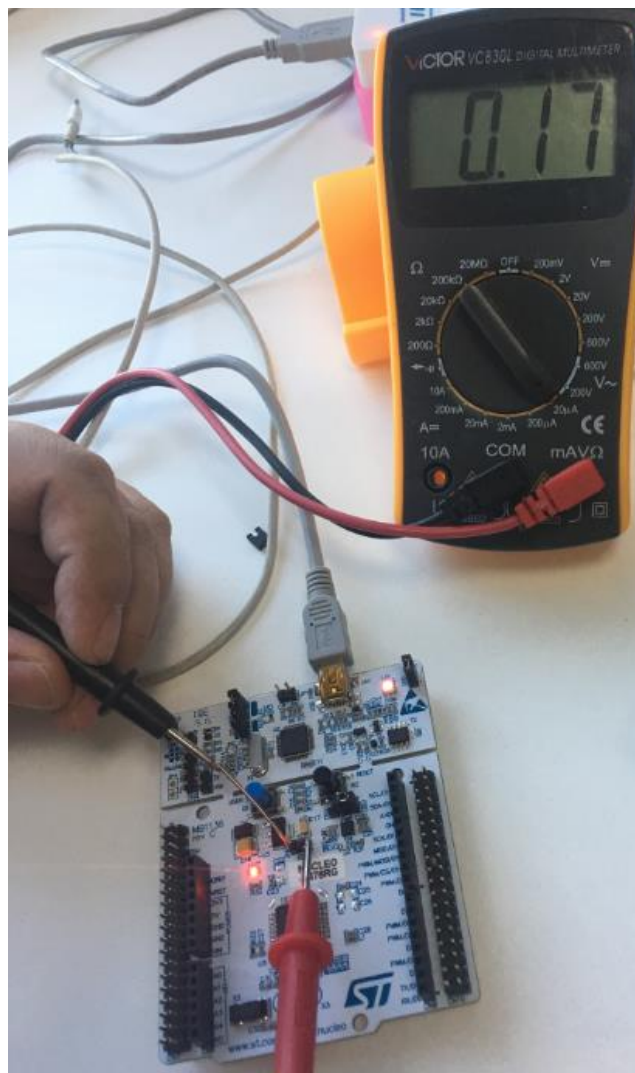
如果是第一次使用ST开发板，需要安装USB虚拟串口驱动，请到培训包Install_Software中找USB Virtual COM安装包

打开Tera Term，找到对应的虚拟串口



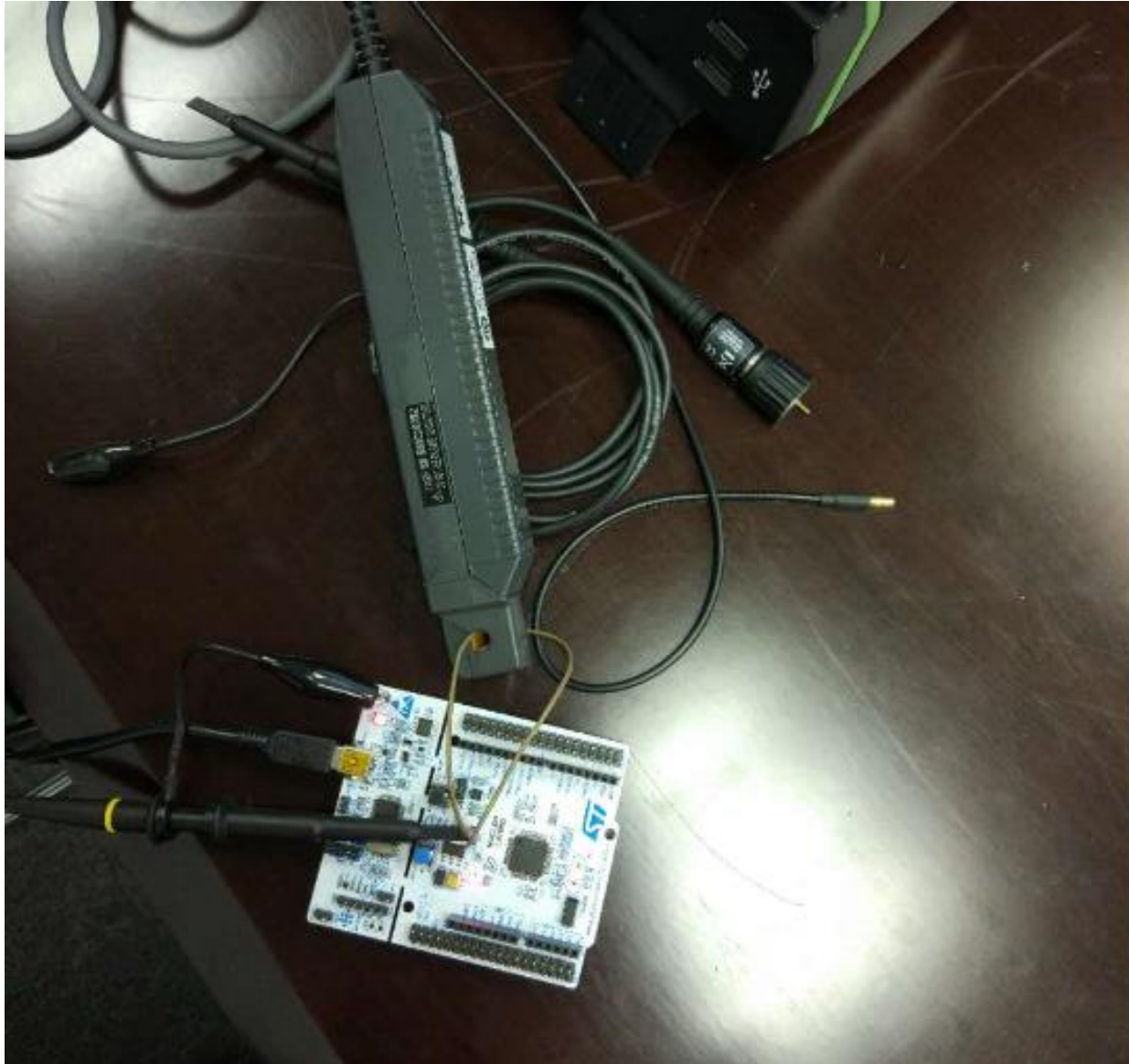
根据提示，输入不同的数字，板子进入相应的工作模式

将电流表串在JP6的两端，实际测得电流



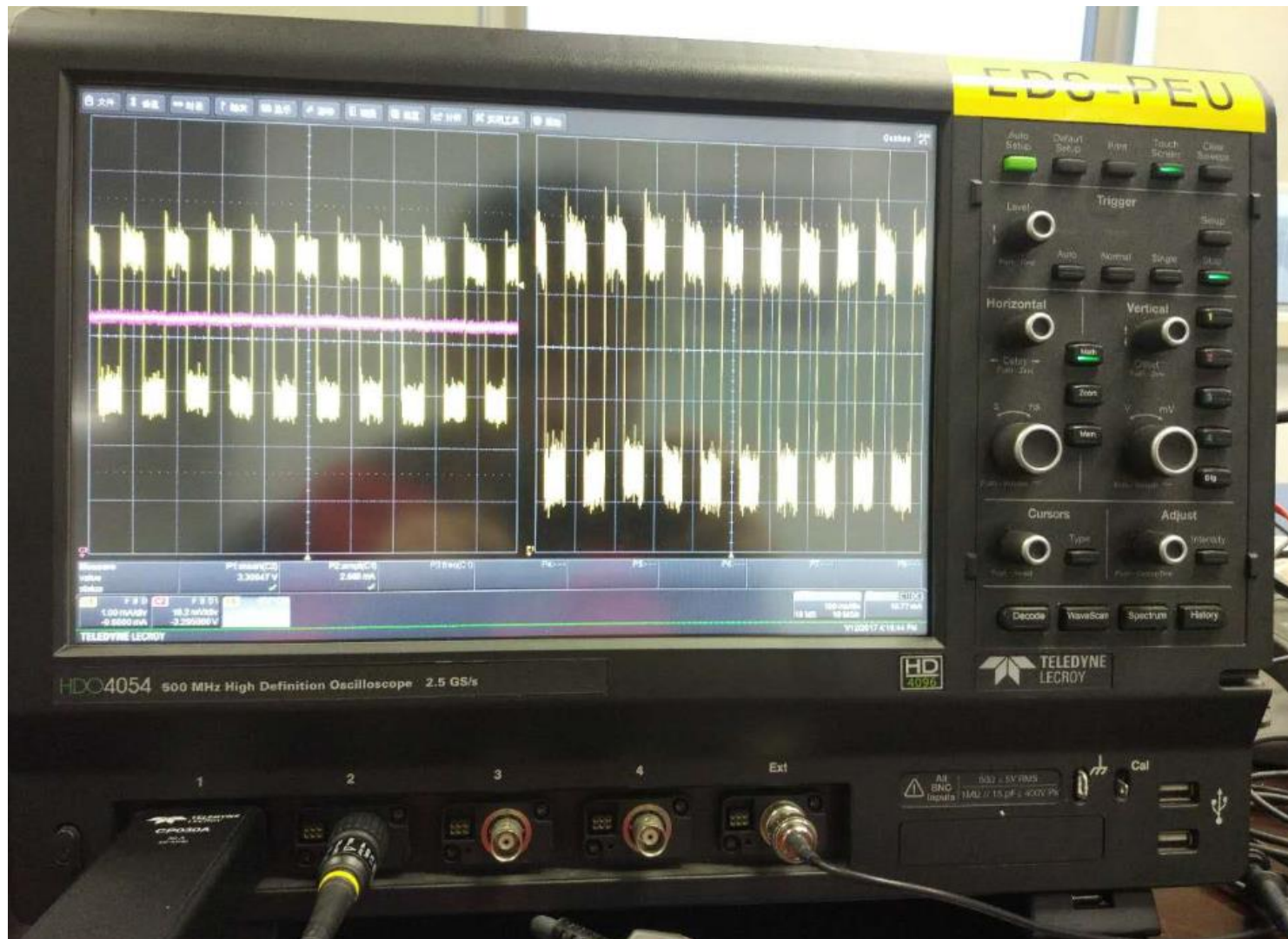
实际测量电流

49



实际测量电流

50

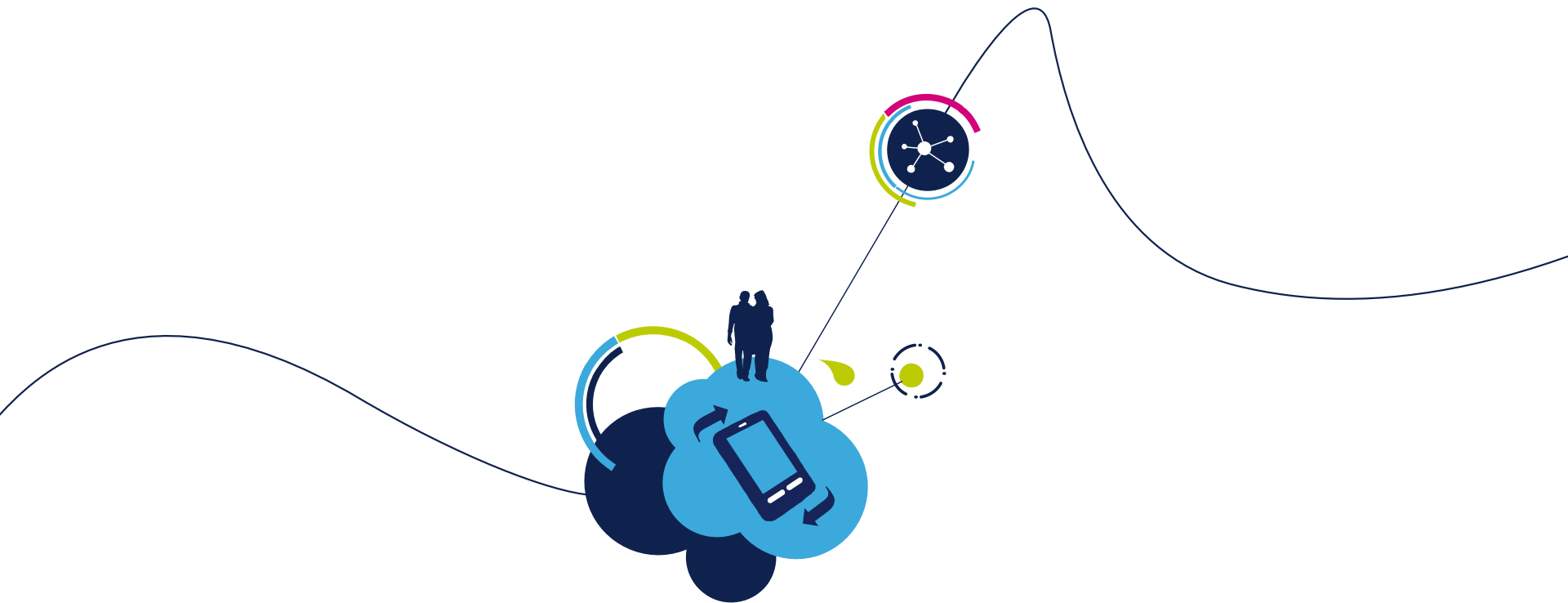


- 测试一下其他低功耗模式下的电流，查看所得数据与数据手册上标称数据是否相符
- 依次测试STOP2模式、STANDBY模式、LPSLEEP模式和SHUTDOWN模式下的功耗, 填入下表，并且与自己在任务2中 功耗计算器获得的理论值做对比：

低功耗模式	实际测量值
SHUTDOWN	
STANDBY	
STOP2	
LPSLEEP 2MHz	

低功耗模式	实际测量值	理论计算值
SHUTDOWN	75nA	64nA @3.0V
STANDBY	165nA	150nA@3.0V
STOP2	1.45uA	1.18uA@3.0V
LPSLEEP 2MHz	85uA	81uA@3.0V

- 今天的动手实验中，我们学习和理解了STML476的低功耗特性和不同低功耗模式。
 - ❑ STML476的低功耗优化特性有了清晰的认识
 - ❑ 如何使用STM32CubeMX从头开始实现一个低功耗工程
 - ❑ 如何使用功耗计算器去理论分析不同功耗模式下的功耗值
 - ❑ 以及如何在NUCLEO板子上实际测得不同功耗值



谢谢

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